MEMORANDUM OF UNDERSTANDING
FOR THE 2013-2014 FERMILAB TEST BEAM FACILITY PROGRAM

T-1031
ATLAS Tile Calorimeter Upgrade Electronics Test
October 12, 2012
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INTRODUCTION

This is a memorandum of understanding between the Fermi National Accelerator Laboratory (Fermilab) and the experimenters of the University of Chicago who have committed to participate in beam tests to be carried out during the 2013-2014 Fermilab Test Beam Facility program.

The memorandum is intended solely for the purpose of recording expectations for budget estimates and work allocations for Fermilab, the funding agencies and the participating institutions. It reflects an arrangement that currently is satisfactory to the parties; however, it is recognized and anticipated that changing circumstances of the evolving research program will necessitate revisions. The parties agree to modify this memorandum to reflect such required adjustments. Actual contractual obligations will be set forth in separate documents.

Description of Detector and Tests:

The on-detector electronics of the ATLAS hadronic calorimeter (Tilecal) at the CERN LHC consist of frontend boards (FEB) that receive and shape PMT signals and send them to a Main Board (MB) that digitizes the signals, controls clocks and parameter setups, serializes and sends data via fiberoptic transceivers. In the LHC and HL-LHC cavern environments the experimenters expect the electronics to experience periodic Single Event Upsets (SEU) and other forms of radiation damage, both recoverable and permanent. Indeed, in the 2011 and 2012 LHC running Tilecal has experienced on the order of one SEU per inverse picobarn of collisions. The experimenters are in the process of designing replacement electronics and complete upgrade systems for the higher energy and intensities of the 2015 running of the LHC. It is therefore essential to monitor the new electronics in an HL-LHC cavern environment to gauge the feasibility of the design.

FNAL accelerator physicists have shown that the M03 alcove near a pinhole collimator has a radiation environment remarkably similar to the HL-LHC caverns under normal running conditions. This alcove proves ideal for the testing of small instrumentation packages. The shielded space next to the alcove is a good location for a rack of monitoring electronics. The experiment therefore proposes to install an instrumentation package (on the order of 30 cm on a side) near the beam pipe in the alcove; this package will include the FEB, MB and LV power supply, and several ion gauges supplied by the University of Chicago. Additionally, signal and power cables will be run from the test package to a half-height relay rack in the shielded area about 3 meters away. This DAQ rack contains the CPU, VME system and ion gauge controller. The system would be monitored in a parasitic mode with the beamline operation, with data transmitted for analysis via Ethernet.
MOU for ATLAS Tile Electronics Test

I. PERSONNEL AND INSTITUTIONS:

Spokesperson: Mark Oreglia

Fermilab liaison: Aria Soha

The group members at present are:

<table>
<thead>
<tr>
<th>Institution</th>
<th>Collaborator</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.1 University of Chicago</td>
<td>Mark Oreglia</td>
</tr>
<tr>
<td></td>
<td>Kelby Anderson</td>
</tr>
<tr>
<td>1.2 Fermilab</td>
<td>Erik Ramberg</td>
</tr>
<tr>
<td>1.3 Argonne National Lab</td>
<td>Gary Drake</td>
</tr>
</tbody>
</table>
MOU for ATLAS Tile Electronics Test

No items from PREP are being requested at this time.

The Front End Boards, and Main Board are custom electronics, everything else is commercial. This system was run for several months in the APS ring at Argonne.

2.3.3 DESCRIPTION OF TESTS

The experiment does not intend to install any material in the beam line itself. Experimenters will install an instrumentation package (on the order of 30 cm on a side) near the beam pipe in the alcove; this package will include the FEB, MB and LV power supply, and several ion gauges supplied by the University of Chicago. Additionally, signal and power cables will be run from the test package to a half-height relay rack in the shielded area about 3 meters away. This DAQ rack contains the CPU, VME system and ion gauge controller.

The system would be monitored from off-site in a parasitic mode with the beamline operation, with data transmitted for analysis via Ethernet. An experiment contact will be available 24/7 and two contact numbers will be registered with MCR operators, and with the Fermilab Liaison.

The experiment proposes to monitor the test package for one month. Additional months of running could be necessary with future versions of the electronics.

2.4 SCHEDULE

The experimenters would like access to the area for approximately one year, with the understanding that the experiment will be parasitic and coexist with other tests conducted in the M03 alcove, or in the MT6 enclosures.
MOU for ATLAS Tile Electronics Test

IV. RESPONSIBILITIES BY INSTITUTION – FERMILAB

4.1 FERMILAB ACCELERATOR DIVISION:

4.1.1 Use of MTest beam as outlined in Section II.
4.1.2 Maintenance of all existing standard beam line elements (SWICs, loss monitors, etc) instrumentation, controls, clock distribution, and power supplies.
4.1.3 Reasonable access to the equipment in the MTest beamline, specifically the M03 enclosure.
4.1.4 The test beam energy and beam line elements will be under the control of the AD Operations Department Main Control Room (MCR). [0.5 person-weeks]
4.1.5 Position and focus of the beam on the experimental devices under test will be under control of MCR.
4.1.6 The integrated effect of running this and other SY120 beams will not reduce the neutrino flux by more than an amount set by the office of Program Planning, with the details of scheduling to be worked out between the experimenters and the Office of Program Planning.

4.2 FERMILAB PARTICLE PHYSICS DIVISION:

4.2.1 The test-beam efforts in this MOU will make use of the Fermilab Test Beam Facility. Requirements for the beam and user facilities are given in Section II. The Fermilab Particle Physics Division will be responsible for coordinating overall activities in the MTest beam-line, including use of the user beam-line controls, readout of the beam-line detectors, and MTest computers. [1.0 person weeks]
4.2.2 Conduct a NEPA review of the experiment.
4.2.3 Provide day-to-day ES&H support/oversight(review of work and documents as necessary.
4.2.4 Provide safety training as necessary, with assistance from the ES&H Section.
4.2.5 Update/create ITNA’s for users on the experiment.
4.2.6 Initiate the ES&H Operational Readiness Clearance Review and any other required safety reviews.

4.3 FERMILAB SCIENTIFIC COMPUTING DIVISION

4.3.1 The experiment requests a network (Ethernet) connection from the DAQ rack in the enclosure, such that the DAQ CPU can be monitored from off site. (Remote Access)

4.4 FERMILAB ES&H SECTION

4.4.1 Assistance with safety reviews.
4.4.2 Provide safety training, with assistance from PPD, as necessary for experimenters. [0.5 person weeks]
VI. **SPECIAL CONSIDERATIONS**

6.1 The responsibilities of the Spokesperson and the procedures to be followed by experimenters are found in the Fermilab publication "Procedures for Researchers": (http://www.fnal.gov/directorate/PFX/PFX.pdf). The Spokesperson agrees to those responsibilities and to follow the described procedures.

6.2 To carry out the experiment a number of Environmental, Safety and Health (ES&H) reviews are necessary. This includes creating an Operational Readiness Clearance document in conjunction with the standing Particle Physics Division committee. The Spokesperson will follow those procedures in a timely manner, as well as any other requirements put forth by the Division’s Safety Officer.

6.3 The system would be monitored from off-site in a parasitic mode with the beamline operation, with data transmitted for analysis via Ethernet. An experiment contact will be available 24/7 and two contact numbers will be registered with MCR operators, and with the Fermilab Liaison.

6.4 All regulations concerning radioactive sources will be followed. No radioactive sources will be carried onto the site or moved without the approval of the Fermilab ES&H section.

6.5 All items in the Fermilab Policy on Computing will be followed by the experimenters. (http://computing.fnal.gov/class/code/policy/cpolicy.pdf).

6.6 The Spokesperson will undertake to ensure that no PREP or computing equipment be transferred from the experiment to another use except with the approval of and through the mechanism provided by the Scientific Computing Division management. The Spokesperson also undertakes to ensure no modifications of PREP equipment take place without the knowledge and written consent of the Computing Division management.

6.7 The experimenters will be responsible for maintaining both the electronics and the computing hardware supplied by them for the experiment. Fermilab will be responsible for repair and maintenance of the Fermilab-supplied electronics. Any items for which the experiment requests that Fermilab performs maintenance and repair should appear explicitly in this agreement.

**At the completion of the experiment:**

6.8 The Spokesperson is responsible for the return of all PREP equipment, computing equipment and non-PREP data acquisition electronics. If the return is not completed after a period of one year after the end of running the Spokesperson will be required to furnish, in writing, an explanation for any non-return.

6.9 The experimenters agree to remove their experimental equipment as the Laboratory requests them to. They agree to remove it expeditiously and in compliance with all ES&H requirements, including those related to transportation. All the expenses and personnel for the removal will be borne by the experimenters unless removal requires facilities and personnel not able to be supplied by them, such a rigging, crane operation, etc.

6.10 The experimenters will assist Fermilab with the disposition of any articles left in the offices they occupied.
MOU for ATLAS Tile Electronics Test

SIGNATURES:

[Signature]
Mark Oreglia, Experiment Spokesperson
10/12/2012

[Signature]
Michael Lindgren, Particle Physics Division, Fermilab
10/15/2012

[Signature]
Roger Dixon, Accelerator Division, Fermilab
10/17/2012

[Signature]
Robert Roser, Scientific Computing Division, Fermilab
10/18/2012

[Signature]
Nancy Grossman, ES&H Section, Fermilab
10/16/2012

[Signature]
Greg Bock, Associate Director for Research, Fermilab
10/24/2012

[Signature]
Stuart Henderson, Associate Director for Accelerators, Fermilab
10/22/2012
MOU for ATLAS Tile Electronics Test

APPENDIX I: MT6 AREA LAYOUT

MTEST AREAS
APPENDIX II: - HAZARD IDENTIFICATION CHECKLIST

Items for which there is anticipated need have been checked. See next page for detailed descriptions of categories.

<table>
<thead>
<tr>
<th>Flammable Gases or Liquids</th>
<th>Other Gas Emissions</th>
<th>Hazardous Chemicals</th>
<th>Other Hazardous /Toxic Materials</th>
</tr>
</thead>
<tbody>
<tr>
<td>Type:</td>
<td>Type:</td>
<td></td>
<td>List hazardous/toxic materials planned for use in a beam line or an experimental enclosure:</td>
</tr>
<tr>
<td>Flow rate:</td>
<td>Flow rate:</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Capacity:</td>
<td>Capacity:</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Radioactive Sources**

<table>
<thead>
<tr>
<th>Permanent Installation</th>
<th>Beryllium (Be)</th>
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</thead>
<tbody>
<tr>
<td>Temporary Use</td>
<td>Lithium (Li)</td>
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</tbody>
</table>

**Target Materials**

<table>
<thead>
<tr>
<th>Type:</th>
<th>Mercury (Hg)</th>
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<tbody>
<tr>
<td>Strength:</td>
<td>Lead (Pb)</td>
</tr>
</tbody>
</table>

**Lasers**

<table>
<thead>
<tr>
<th>Permanent installation</th>
<th>Uranium (U)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Temporary installation</td>
<td>Other:</td>
</tr>
</tbody>
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**Nuclear Materials**

**Electrical Equipment**

<table>
<thead>
<tr>
<th>Calibration</th>
<th>Electrical devices</th>
<th>Name:</th>
<th>Weight:</th>
</tr>
</thead>
<tbody>
<tr>
<td>Alignment</td>
<td>Cryo/Electrical devices</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Mechanical Structures**

<table>
<thead>
<tr>
<th>Type:</th>
<th>Capacitor Banks</th>
<th>Mechanical Structures</th>
</tr>
</thead>
<tbody>
<tr>
<td>Wattage:</td>
<td>High Voltage (50V)</td>
<td>Lifting Devices</td>
</tr>
<tr>
<td>Class:</td>
<td>Exposed Equipment over 50 V</td>
<td>Motion Controllers</td>
</tr>
<tr>
<td></td>
<td>X Non-commercial/Non-PREP</td>
<td>Scaffolding/ Elevated Platforms</td>
</tr>
<tr>
<td></td>
<td>Modified Commercial/PREP</td>
<td>Other:</td>
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</table>

**Vacuum Vessels**

<table>
<thead>
<tr>
<th>Pressure Vessels</th>
<th>Cryogenics</th>
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</thead>
<tbody>
<tr>
<td>Inside Diameter:</td>
<td>Beam line magnets</td>
</tr>
<tr>
<td>Operating Pressure:</td>
<td>Analysis magnets</td>
</tr>
<tr>
<td>Window Material:</td>
<td>Target</td>
</tr>
<tr>
<td>Window Thickness:</td>
<td>Bubble chamber</td>
</tr>
</tbody>
</table>